

**CMLM0584
MULTI DISCRETE MODULE™**

**SURFACE MOUNT SILICON
P-CHANNEL MOSFET AND
LOW V_F SCHOTTKY DIODE**

PICOmini™

MDM™
Multi Discrete Module



SOT-563 CASE

- Device is **Halogen Free** by design

APPLICATIONS:

- DC / DC Converters
- Battery Powered Portable Equipment

MAXIMUM RATINGS - CASE: (T_A=25°C)

Power Dissipation (Note 1)
Power Dissipation (Note 2)
Power Dissipation (Note 3)
Operating and Storage Junction Temperature
Thermal Resistance

MAXIMUM RATINGS - Q1: (T_A=25°C)

Drain-Source Voltage
Gate-Source Voltage
Continuous Drain Current

MAXIMUM RATINGS - D1: (T_A=25°C)

Peak Repetitive Reverse Voltage
Continuous Forward Current
Peak Repetitive Forward Current, tp≤1.0ms
Peak Forward Surge Current, tp=8.0ms

ELECTRICAL CHARACTERISTICS - Q1: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _{GSSF} , I _{GSSR}	V _{GS} =8.0V, V _{DS} =0			3.0	μA
I _{DSS}	V _{DS} =30V, V _{GS} =0			1.0	μA
BV _{DSS}	V _{GS} =0, I _D =100μA	30			V
V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5		1.0	V
V _{SD}	V _{GS} =0, I _S =100mA	0.5		1.1	V
r _{DS(ON)}	V _{GS} =4.5V, I _D =430mA			1.1	Ω
r _{DS(ON)}	V _{GS} =2.5V, I _D =200mA			2.0	Ω
r _{DS(ON)}	V _{GS} =1.8V, I _D =100mA			3.3	Ω
g _{FS}	V _{DS} =10V, I _D =100mA	200			mS

- Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 4.0mm²
(2) FR-4 Epoxy PC Board with copper mounting pad area of 4.0mm²
(3) FR-4 Epoxy PC Board with copper mounting pad area of 1.4mm²



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMLM0584 is a Multi Discrete Module™ consisting of a single P-Channel Enhancement-mode MOSFET and a Low V_F Schottky diode packaged in a space saving PICOmini™ SOT-563 surface mount case. This device is designed for small signal general purpose applications where size and operational efficiency are prime requirements.

MARKING CODE: 58C

FEATURES:

- ESD protection up to 2kV
- Low r_{DS(on)} Transistor (1.5Ω MAX @ V_{GS}=2.5V)
- Low V_F Schottky Diode (0.47V MAX @ 0.5A)

SYMBOL		UNITS
P _D	350	mW
P _D	300	mW
P _D	150	mW
T _J , T _{stg}	-65 to +150	°C
θ _{JA}	357	°C/W

SYMBOL		UNITS
V _{DS}	30	V
V _{GS}	8.0	V
I _D	450	mA

SYMBOL		UNITS
V _R RM	40	V
I _F	500	mA
I _{FRM}	3.5	A
I _{FSM}	10	A

R2 (2-August 2011)

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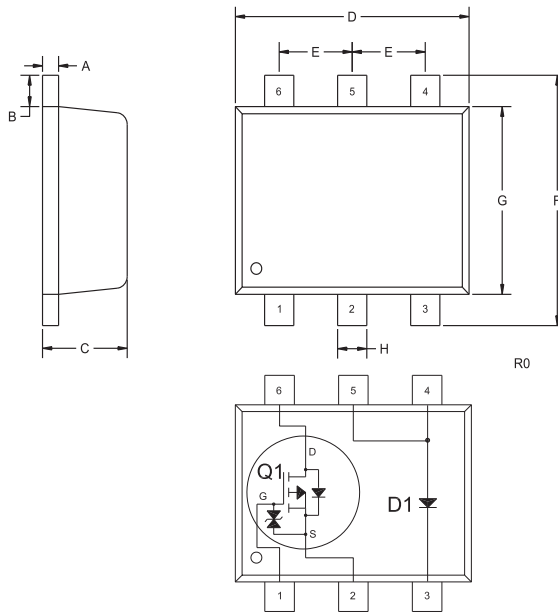
ELECTRICAL CHARACTERISTICS - Q1 - Continued: ($T_A=25^\circ\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	MAX	UNITS
$Q_{g(\text{tot})}$	$V_{DS}=10\text{V}$, $V_{GS}=4.5$, $I_D=1.0\text{A}$	0.88	nC
Q_{gs}	$V_{DS}=10\text{V}$, $V_{GS}=4.5$, $I_D=1.0\text{A}$	0.35	nC
Q_{gd}	$V_{DS}=10\text{V}$, $V_{GS}=4.5$, $I_D=1.0\text{A}$	0.128	nC
C_{rss}	$V_{DS}=25\text{V}$, $V_{GS}=0$, $f=1.0\text{MHz}$	10	pF
C_{iss}	$V_{DS}=25\text{V}$, $V_{GS}=0$, $f=1.0\text{MHz}$	55	pF
C_{oss}	$V_{DS}=25\text{V}$, $V_{GS}=0$, $f=1.0\text{MHz}$	15	pF

ELECTRICAL CHARACTERISTICS - D1: ($T_A=25^\circ\text{C}$)

SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_R	$V_R=10\text{V}$		20	μA
I_R	$V_R=30\text{V}$		100	μA
BV_R	$I_R=500\mu\text{A}$	40		V
V_F	$I_F=100\mu\text{A}$		0.13	V
V_F	$I_F=1.0\text{mA}$		0.21	V
V_F	$I_F=10\text{mA}$		0.27	V
V_F	$I_F=100\text{mA}$		0.35	V
V_F	$I_F=500\text{mA}$		0.47	V
C_T	$V_R=1.0\text{V}$, $f=1.0\text{MHz}$		50	pF

SOT-563 CASE - MECHANICAL OUTLINE



SYMBOL	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.004	0.007	0.10	0.18
B	0.008		0.20	
C	0.022	0.024	0.56	0.60
D	0.059	0.067	1.50	1.70
E	0.020		0.50	
F	0.061	0.067	1.55	1.70
G	0.047		1.20	
H	0.006	0.012	0.15	0.30

SOT-563 (REV: R0)

LEAD CODE:

- 1) Gate Q1
- 2) Source Q1
- 3) Cathode D1
- 4) Anode D1
- 5) Anode D1
- 6) Drain Q1

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